

40V 250mA Ultralow Quiescent Current LDO

General Description

The EHP8041 is a high voltage, low quiescent current, low dropout regulator with 250mA output driving capacity. The EHP8041, which operates over an input range up to 40V, is stable with any capacitors, whose capacitance is larger than 1 μ F, and suitable for powering battery-management ICs because of the virtue of its low quiescent current consumption and low dropout voltage.

The EHP8041 is available in SOT-23-3, SOT-23-5, SOT-89-3 and TDFN3x3-8L surface mount packages.

Features

- Up to 40V input voltage range
- 250mA output current driving capacity
- Ultra low quiescent current (typical 1.5 μ A)
- 1200mV typical dropout at $I_{OUT} = 250\text{ mA}$
- Thermal shutdown protection
- Short circuit protection
- Stable with 1 μ F output capacitor

Applications

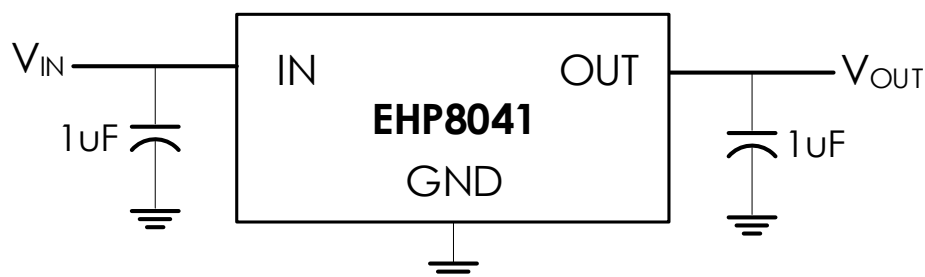
- Logic Supply for High Voltage Batteries
- 3-4 Cell Li-ion Batteries Powered systems

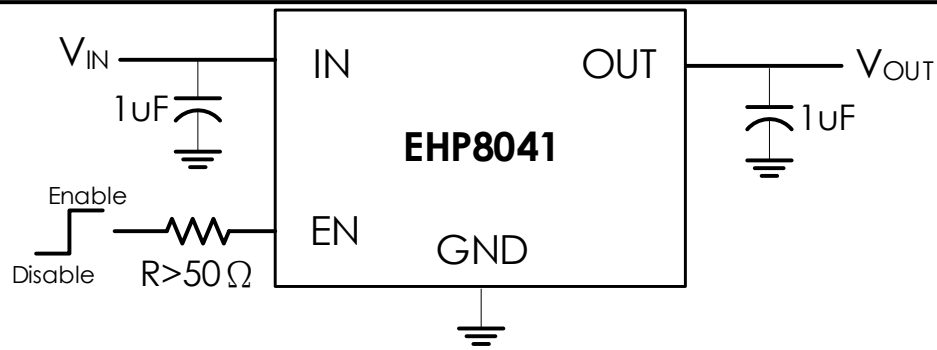
Ordering Information

Part Number	Remark
EHP8041-XXVD03NRR	$\pm 2\%$ output voltage tolerance
EHP8041-XXVF05NRR	$\pm 2\%$ output voltage tolerance
EHP8041-XXVL03NRR	$\pm 2\%$ output voltage tolerance
EHP8041-XXVLX3NRR	
EHP8041-XXFF08NRR	$\pm 2\%$ output voltage tolerance

XX: 15=1.5V, 18=1.8V, 25=2.5V, 33=3.3V, 50=5.0V

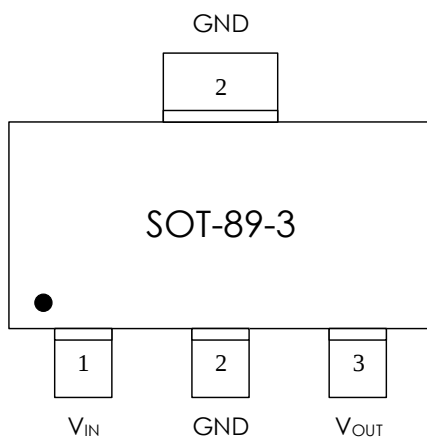
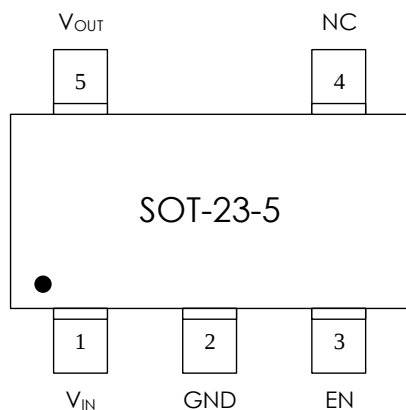
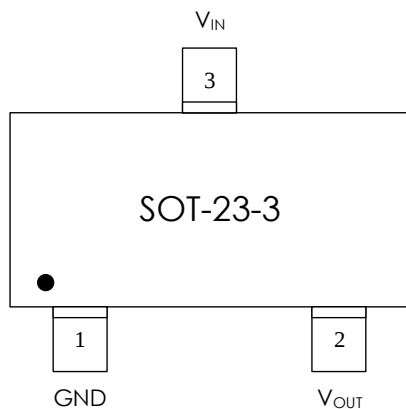
Typical Application





*A resistor larger than 50Ω between enable signal and EN pin is recommended.

Connection Diagrams

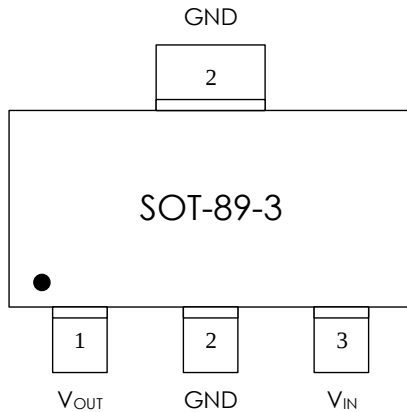


Order information

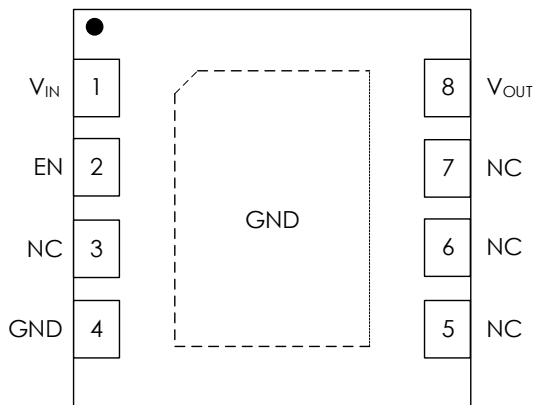
EHP8041-XXVD03NRR
 XX Output voltage
 VD03 SOT-23-3 Package
 NRR RoHS & Halogen free package
 Rating: -40 to 85°C
 Package in Tape & Reel

EHP8041-XXVF05NRR
 XX Output voltage
 VF05 SOT-23-5 Package
 NRR RoHS & Halogen free package
 Rating: -40 to 85°C
 Package in Tape & Reel

EHP8041-XXVL03NRR
 XX Output voltage
 VL03 SOT-89-3 Package
 NRR RoHS & Halogen free package
 Rating: -40 to 85°C
 Package in Tape & Reel



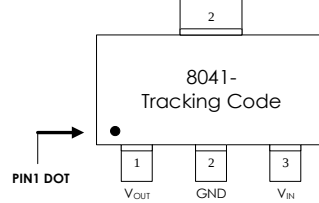
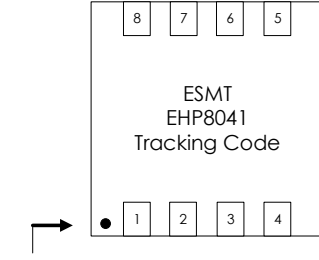
EHP8041-XXVLX3NRR
 XX Output voltage
 VLX3 SOT-89-3 Package
 NRR RoHS & Halogen free package
 Rating: -40 to 85°C
 Package in Tape & Reel



EHP8041-XXFF08NRR
 XX Output voltage
 FF08 TDFN3x3-8L Package
 NRR RoHS & Halogen free package
 Rating: -40 to 85°C
 Package in Tape & Reel

Order, Marking and Packing Information

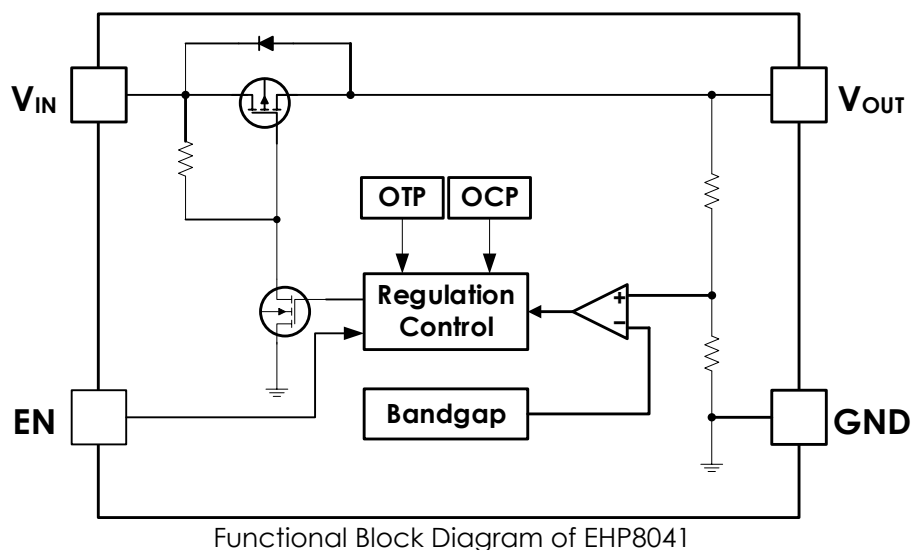
Package	Vout	Product ID.	Marking	Packing
SOT-23-3	1.5V	EHP8041-15VD03NRR		Tape & Reel 3Kpcs
	1.8V	EHP8041-18VD03NRR		
	2.5V	EHP8041-25VD03NRR		
	3.3V	EHP8041-33VD03NRR		
	5.0V	EHP8041-50VD03NRR		
SOT-23-5	1.5V	EHP8041-15VF05NRR		Tape & Reel 3Kpcs
	1.8V	EHP8041-18VF05NRR		
	2.5V	EHP8041-25VF05NRR		
	3.3V	EHP8041-33VF05NRR		
	5.0V	EHP8041-50VF05NRR		
SOT-89-3	1.5V	EHP8041-15VL03NRR		Tape & Reel 1Kpcs
	1.8V	EHP8041-18VL03NRR		
	2.5V	EHP8041-25VL03NRR		
	3.3V	EHP8041-33VL03NRR		

	5.0V	EHP8041-50VL03NRR		
SOT-89-3	1.5V	EHP8041-15VLX3NRR		Tape & Reel 1Kpcs
	1.8V	EHP8041-18VLX3NRR		
	2.5V	EHP8041-25VLX3NRR		
	3.3V	EHP8041-33VLX3NRR		
	5.0V	EHP8041-50VLX3NRR		
TDFN3x3-8L	1.5V	EHP8041-15FF08NRR		Tape & Reel 5Kpcs
	1.8V	EHP8041-18FF08NRR		
	2.5V	EHP8041-25FF08NRR		
	3.3V	EHP8041-33FF08NRR		
	5.0V	EHP8041-50FF08NRR		

Pin Functions

Name	SOT-23-3	SOT-23-5	SOT-89-3		TDFN3x3-8L	Function
			0	X		
VIN	3	1	1	3	1	Supply voltage input Require a minimum input capacitor of close to 1μF to ensure stability and sufficient decoupling from the ground pin.
GND	1	2	2	2	4, Exposed Pad	Ground pin
EN	N/A	3	N/A	N/A	2	Enable input. A resistor larger than 50 ohm is recommended to connect to EN pin.
NC	N/A	4	N/A	N/A	3,5,6,7	No connection
VOU	2	5	3	1	8	Output voltage

Functional Block Diagram



Absolute Maximum Ratings (Note 1, 2)

V_{IN}, EN	-0.3V to 43V	V_{out}	-0.3V to 6V
Junction Temperature	150°C	Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	-65°C to 150°C	ESD Rating: Human Body Model	2KV

Recommended Operating Conditions (Note 1, 2)

Supply Voltage	2.7V to 40V	Operating Temperature Range	-40°C to 85°C
Junction Temperature Range	-40°C to 125°C		

Thermal Resistance:

Symbol	θ_{JA} (Note 3)	θ_{JC} (Note 4)
SOT-23-3	250(°C/W)	81(°C/W)
SOT-23-5	152(°C/W)	81(°C/W)
SOT-89-3	90(°C/W)	52(°C/W)
TDFN3x3-8L	72.5(°C/W)	23(°C/W)

Electrical Characteristics

$V_{IN}=12V$, $I_{OUT}=1mA$, $C_{IN}=C_{OUT}=1\mu F$, $T_a = 25^\circ C$, unless otherwise specified

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Output Voltage	V_{OUT}		-2%		2%	V
Line Regulation	ΔV_{LINE}	$V_{IN}=V_{OUT} + 1V$ to 40V,		0.1		%
Load Regulation	ΔV_{LOAD}	$I_{OUT}= 1mA$ to 100mA		0.5		%
Dropout Voltage	V_{DROP}	$I_{OUT}=100mA$		400		mV
		$I_{OUT}=250mA$		1200		mV
Quiescent Current	I_Q	$T_a= 25^\circ C$, No load		1.5	5.0	μA
Current Limit	I_{CL}		270	340		mA
Enable high level	V_{ENHI}		0.9			V
Enable low level	V_{ENLO}				0.4	V
Enable pin pull high current	I_{EN}			0.1		μA
Thermal Shutdown	T_{SD}			140		°C
Thermal Shutdown Hysteresis	T_{HY}			20		°C
Power-supply rejection ratio	PSRR	$f = 1kHz$, $V_{in}=4.3V$ $V_o = 3.3V$, Ripple 0.2Vp-p, $I_{out} = 1mA$		55		dB

Note 1: Absolute Maximum ratings indicate limits beyond which damage may occur. Electrical specifications do not apply when operating the device outside of its rated operating conditions.

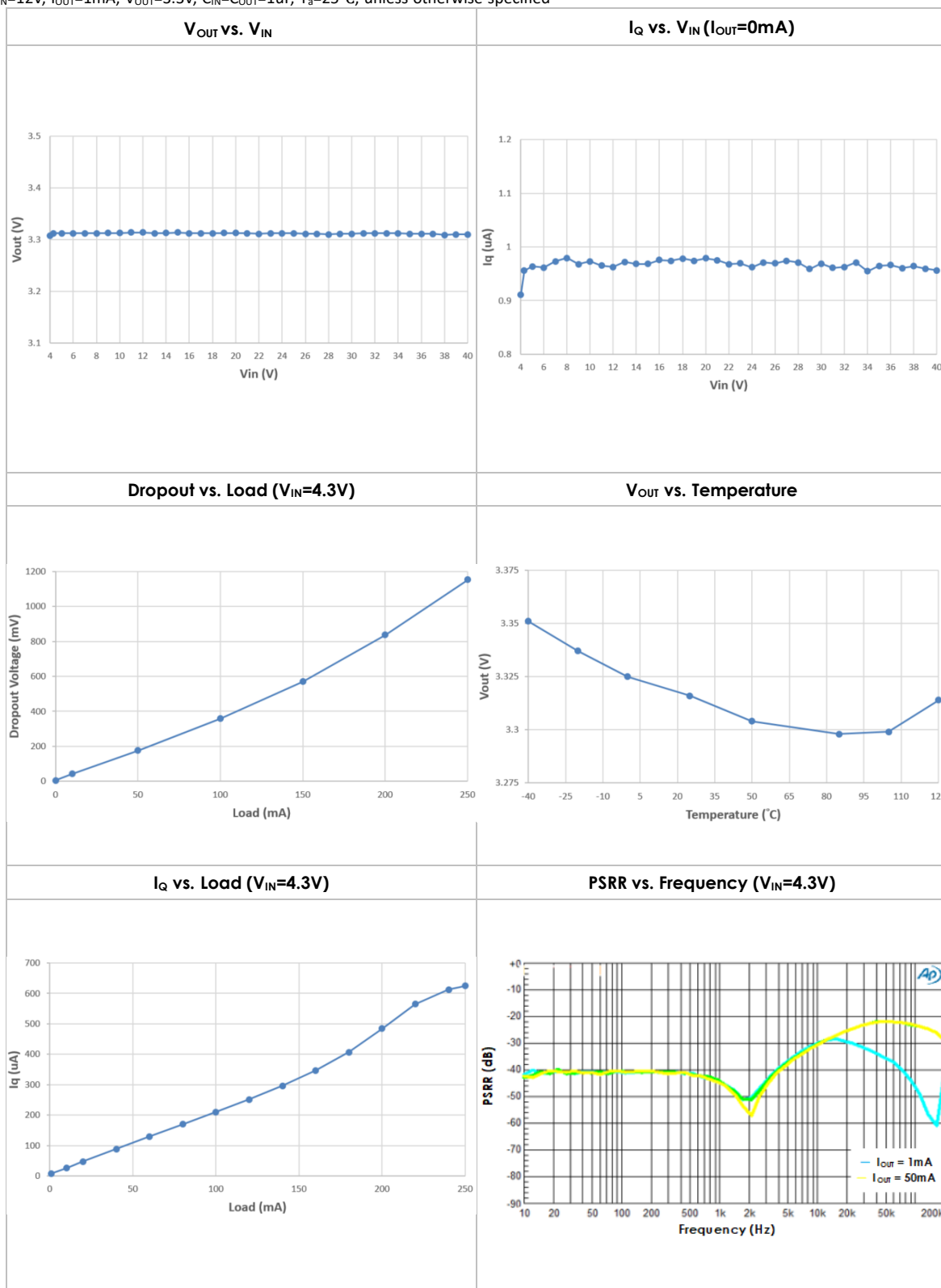
Note 2: All voltages are with respect to the potential at the ground pin.

Note 3: θ_{JA} is measured in the natural convection at $T_J=25^\circ C$ on a high effective thermal conductivity test board (2 layers, 2S0P).

Note 4: θ_{JC} represents the resistance to the heat flows the chip to package top case.

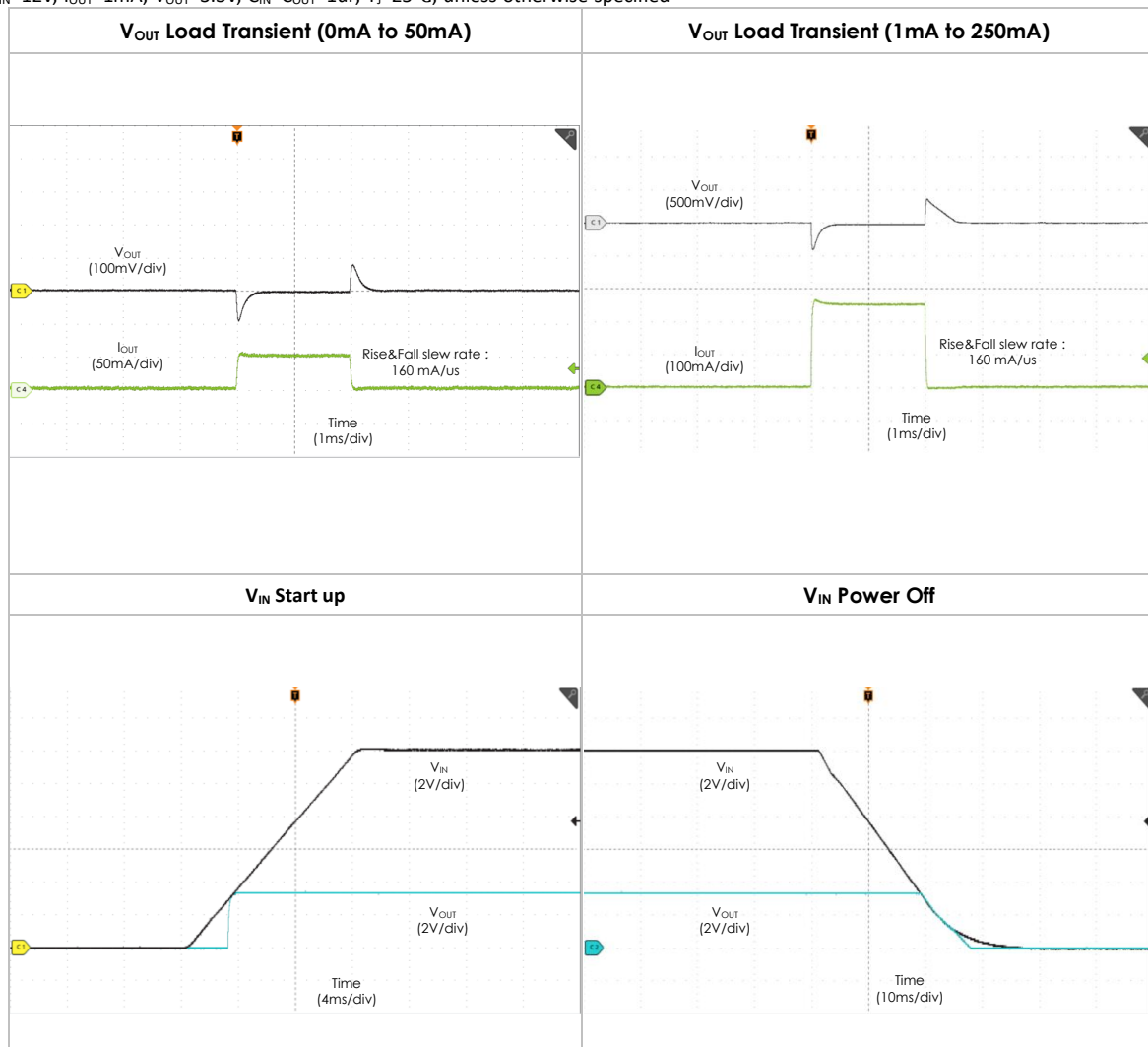
Typical Performance Characteristics

$V_{IN}=12V$, $I_{OUT}=1mA$, $V_{OUT}=3.3V$, $C_{IN}=C_{OUT}=1\mu F$, $T_a=25^{\circ}C$, unless otherwise specified



Typical Performance Characteristics (cont.)

$V_{IN}=12V$, $I_{OUT}=1mA$, $V_{OUT}=3.3V$, $C_{IN}=C_{OUT}=1\mu F$, $T_J=25^{\circ}C$, unless otherwise specified



Application Information

Output Capacitor

The EHP8041 is specially designed for use with ceramic output capacitors of as low as 1 μF to take advantage of the savings in cost and space as well as the superior filtering of high frequency noise. Capacitors of higher value or other types may be used, but it is important to make sure its equivalent series resistance (ESR) is restricted to less than 0.5 Ω . The use of larger capacitors with smaller ESR values is desirable for applications involving large and fast input or output transients, as well as for situations where the application systems are not physically located immediately adjacent to the battery power source. Typical ceramic capacitors suitable for use with the EHP8041 are X5R and X7R. The X5R and the X7R capacitors are able to maintain their capacitance values to within $\pm 20\%$ and $\pm 10\%$, respectively, as the temperature increases.

Input Capacitor

A minimum input capacitance of 1 μF is required for EHP8041. The capacitor value may be increased without limit. Improper workbench set-ups may have adverse effects on the normal operation of the regulator. A case in point is the instability that may result from long supply lead inductance coupling to the output through the gate capacitance of the pass transistor. This will establish a pseudo LCR network, and is likely to happen under high current conditions or near dropout. A 10 μF tantalum input capacitor will dampen the parasitic LCR action thanks to its high ESR. However, cautions should be exercised to avoid regulator short-circuit damage when tantalum capacitors are used, for they are prone to fail in short-circuit operating conditions.

Power Dissipation and Thermal Shutdown

Thermal overload results from excessive power dissipation that causes the IC junction temperature to increase beyond a safe operating level. The EHP8041 relies on dedicated thermal shutdown circuitry to limit its total power dissipation. An IC junction temperature T_J exceeding 140 $^{\circ}\text{C}$ will trigger the thermal shutdown logic, turning off the P-channel MOS pass transistor. The pass transistor turns on again after the junction cools off by about 20 $^{\circ}\text{C}$. When continuous thermal overload conditions persist, this thermal shutdown action then results in a pulsed waveform at the output of the regulator. The concept of thermal resistance θ_{JA} ($^{\circ}\text{C}/\text{W}$) is often used to describe an IC junction's relative readiness in allowing its thermal energy to dissipate to its ambient air. An IC junction with a low thermal resistance is preferred because it is relatively effective in dissipating its thermal energy to its ambient, thus resulting in a relatively low and desirable junction temperature. The relationship between θ_{JA} and T_J is as follows:

$$T_J = \theta_{JA} \times (P_D) + T_A$$

T_A is the ambient temperature, and P_D is the power generated by the IC and can be written as:

$$P_D = I_{OUT} (V_{IN} - V_{OUT})$$

As the above equations show, it is desirable to work with ICs whose θ_{JA} values are small such that T_J does not

increase strongly with P_D . To avoid thermally overloading the EHP8041, refrain from exceeding the absolute maximum junction temperature rating of 125°C under continuous operating conditions. Overstressing the regulator with high loading currents and elevated input-to-output differential voltages can increase the IC die temperature significantly.

Maximum power dissipation for the device is calculated using the following equation:

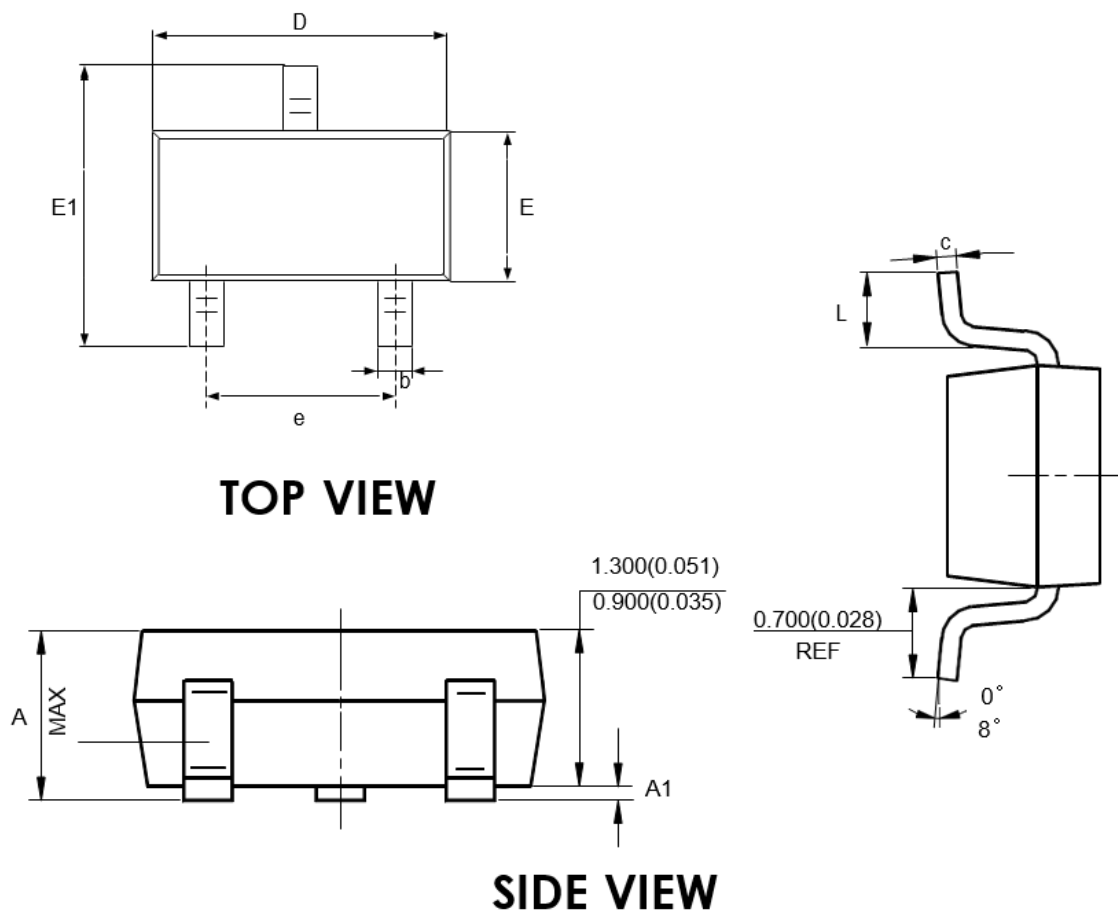
$$PD = \frac{T_{J(max)} - T_A}{\theta_{JA}}$$

Where $T_{J(max)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance. For example,

- SOT-23-3 package, $\theta_{JA}=250^{\circ}\text{C/W}$, $T_{J(max)}=125^{\circ}\text{C}$ and using $T_A=25^{\circ}\text{C}$, the maximum power dissipation is 0.4W.
- SOT-23-5 package, $\theta_{JA}=152^{\circ}\text{C/W}$, $T_{J(max)}=125^{\circ}\text{C}$ and using $T_A=25^{\circ}\text{C}$, the maximum power dissipation is 0.65W.
- SOT-89-3 package, $\theta_{JA}=90^{\circ}\text{C/W}$, $T_{J(max)}=125^{\circ}\text{C}$ and using $T_A=25^{\circ}\text{C}$, the maximum power dissipation is 1.1W.
- TDFN3x3-8L package, $\theta_{JA}=72.5^{\circ}\text{C/W}$, $T_{J(max)}=125^{\circ}\text{C}$ and using $T_A=25^{\circ}\text{C}$, the maximum power dissipation is 1.38W.

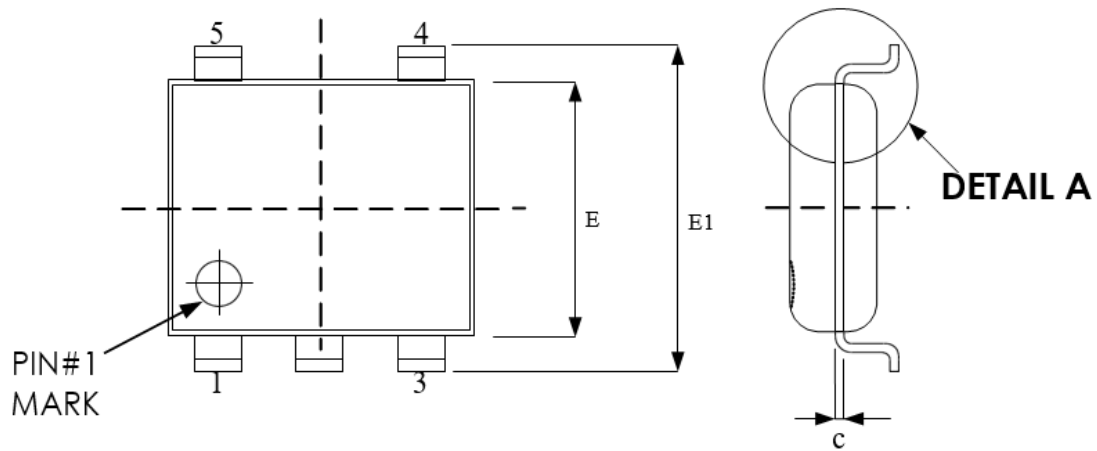
Shutdown

The EHP8041 enters the sleep mode when the EN pin is low. When this occurs, the pass transistor, the error amplifier, and the biasing circuits, including the bandgap reference, are turned off, thus reducing the supply current to typically 1μA. Such a low supply current makes the EHP8041 best suited for battery-powered applications. The maximum guaranteed voltage at the EN pin for the sleep mode to take effect is 0.4V.

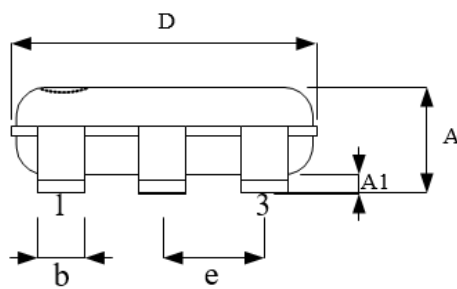
Package Outline Drawing
SOT-23-3

Symbol	Dimension in mm	
	Min.	Max.
A	0.90	1.45
A1	0.00	0.15
b	0.30	0.50
c	0.10	0.20
D	2.82	3.10
E	1.50	1.70
E1	2.60	3.00
e	1.80	2.00
L	0.30	0.60

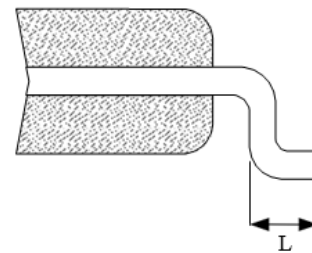
Package Outline Drawing SOT-23-5



TOP VIEW

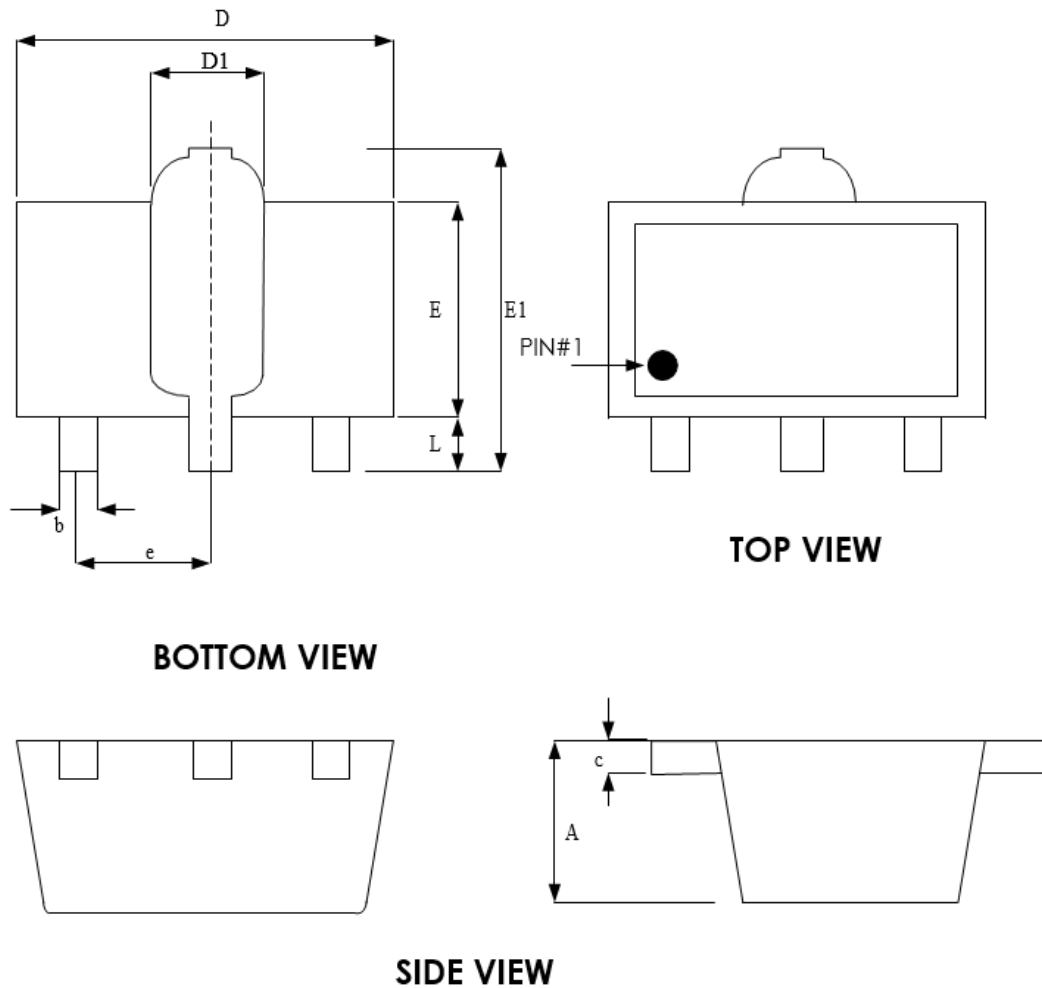


SIDE VIEW

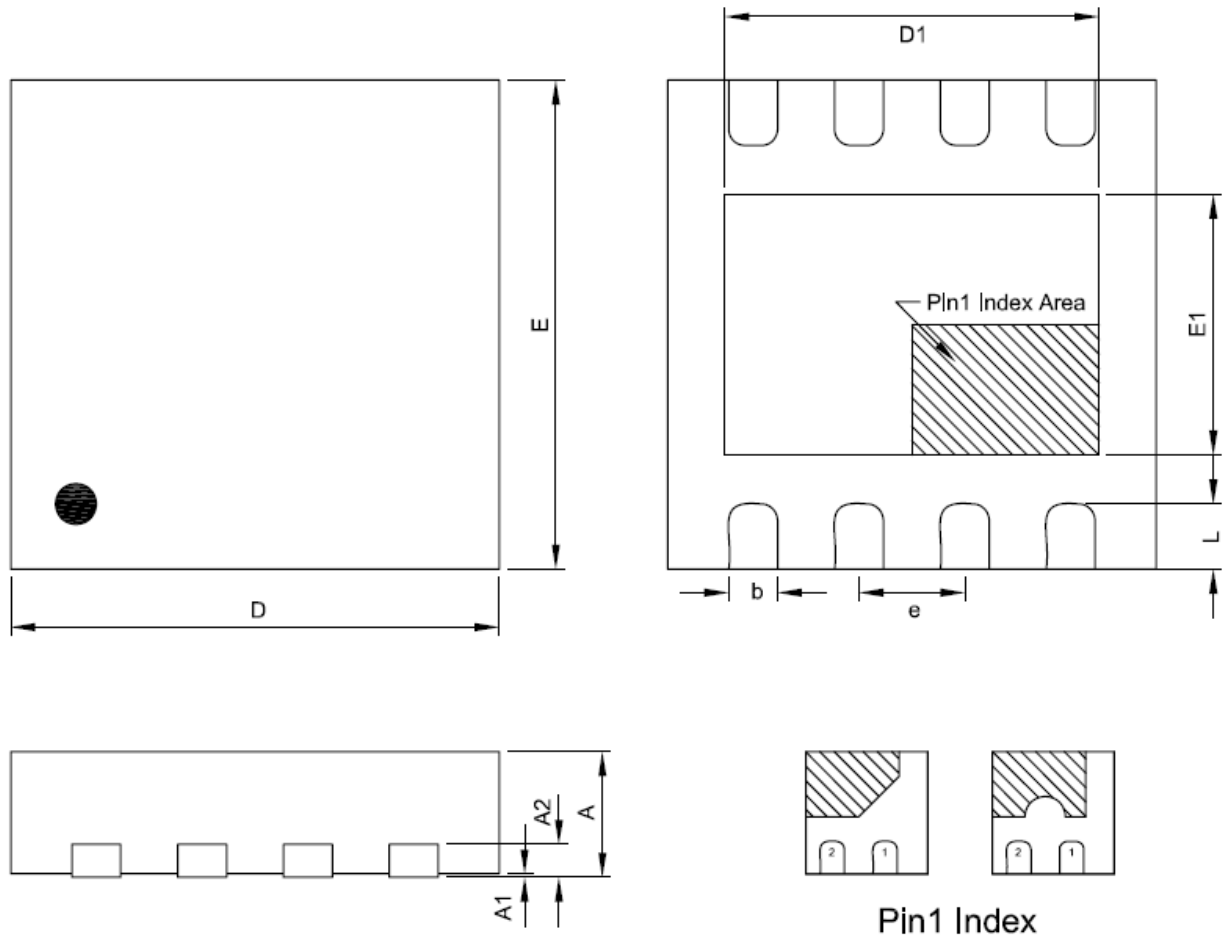


DETAIL A

Symbol	Dimension in mm	
	Min.	Max.
A	0.90	1.45
A1	0.00	0.15
b	0.30	0.50
c	0.08	0.25
D	2.70	3.10
E	1.40	1.80
E1	2.60	3.00
e	0.95 BSC	
L	0.30	0.60

Package Outline Drawing
SOT-89-3

Symbol	Dimension in mm	
	Min	Max
A	1.4	1.6
b	0.4	0.56
c	0.35	0.41
D	4.4	4.6
D1	1.5	1.83
E	2.29	2.6
E1	3.94	4.25
e	1.50 BSC	
L	0.89	1.2

Package Outline Drawing**TDFN 3x3-8L**

Symble	DIMENSION IN MM			DIMENSION IN INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0,70	0,75	0,80	0,0276	0,0295	0,0315
A1	0,00	---	0,05	0,0000	---	0,0020
A2	0,19	0,20	0,21	0,0075	0,0079	0,0083
D	2,95	3,00	3,05	0,1161	0,1181	0,1201
E	2,95	3,00	3,05	0,1161	0,1181	0,1201
D1	2,20	2,30	2,40	0,0866	0,0906	0,0945
E1	1,40	1,50	1,60	0,0551	0,0591	0,0630
b	0,25	0,30	0,35	0,0098	0,0118	0,0138
e	0,65 BSC			0,0256 BSC		
L	0,35	0,45	0,525	0,0138	0,0177	0,0207

Revision History

Revision	Date	Description
1.0	2024.04.22	Original
1.1	2025.11.21	Modify Quiescent Current Maximum from 4uA to 5uA

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